

N-Channel Super Junction Power MOSFET $\, III \,$

General Description

The series of devices use advanced super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- •New technology for high voltage device
- •Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

Package Marking And Ordering Information

Device	Device Package	Marking
NCE65TF041T	TO-247	NCE65TF041T

$\begin{array}{c|cccc} V_{DS} & 650 & V \\ \overline{R_{DS(ON) TYP.}} & 36 & m\Omega \\ I_D & 75 & A \\ \hline G & & & \\ G & & & \\ G & & & \\ S & & \\$

Schematic diagram



Table 1. Absolute Maximum Ratings (T_c=25 $^{\circ}$ C)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGs=0V)	Vds	650	V
Gate-Source Voltage (VDs=0V) AC (f>1 Hz)	Vgs	±30	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	75	А
Continuous Drain Current at Tc=100°C	I _{D (DC)}	47	А
Pulsed drain current (Note 1)	DM (pluse)	300	А
Maximum Power Dissipation(Tc=25°C)	PD	510	W
Derate above 25°C		4.08	W/°C
Single pulse avalanche energy (Note 2)	Eas	1936	mJ
Avalanche current ^(Note 1)	I _{AR}	28	А
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	2.5	mJ



NCE65TF041T

Parameter	Symbol	Value	Unit
Drain Source voltage slope, $V_{DS} \leq 480 V$,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \leqslant 480 V, I_{SD} < I_D$	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	TJ,TSTG	-55+150	°C

* limited by maximum junction temperature

Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	0.245	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =500µA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			5	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			500	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =500µA	2.5	3.5	4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =38A		36	41	mΩ
Dynamic Characteristics						
Input Capacitance	C _{lss}			7300	8500	PF
Output Capacitance	C _{oss}	V _{DS} =100V,V _{GS} =0V,		252		PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		4		PF
Total Gate Charge	Qg			116	135	nC
Gate-Source Charge	Q _{gs}	V _{DS} =480V,I _D =75A,		40		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		30		nC
Switching times	·	·				
Turn-on Delay Time	t _{d(on)}			27		nS
Turn-on Rise Time	tr	V _{DD} =380V,I _D =38A, R _G =1.2Ω,V _{GS} =10V		22		nS
Turn-Off Delay Time	t _{d(off)}			118	180	nS
Turn-Off Fall Time	t _f			13	30	nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T _C =25°C		75		Α
Pulsed Source-drain current(Body Diode)	I _{SDM}			300		Α
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =75A,V _{GS} =0V		1.3		V
Reverse Recovery Time	t _{rr}	− Tj=25°C,I _F =38A,di/dt=100A/µs − V _{DD} =300V		230		nS
Reverse Recovery Charge	Qrr			3		uC
Peak Reverse Recovery Current	I rrm			26		Α

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe Operating Area

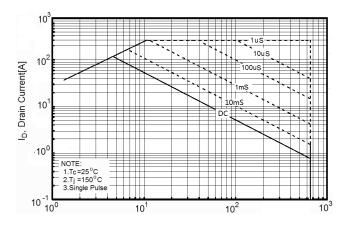


Figure4. Output Characteristics

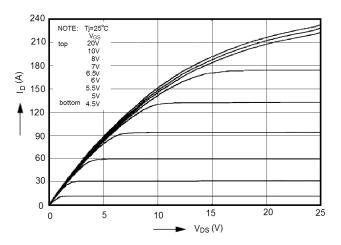


Figure6. Static drain-source on resistance

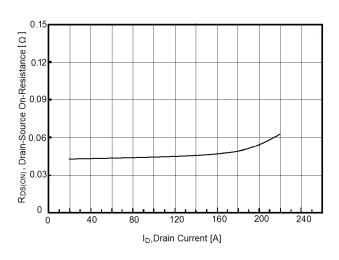


Figure3. Source-Drain Diode Forward Voltage

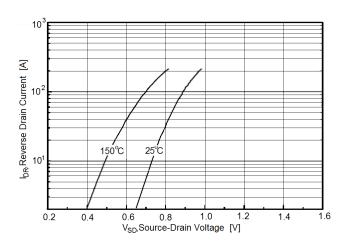


Figure 5. Transfer Characteristics

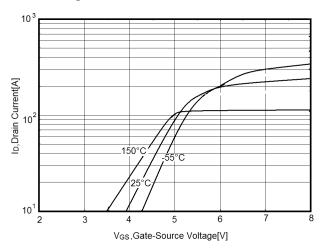


Figure7. R_{DS(ON)} vs Junction Temperature

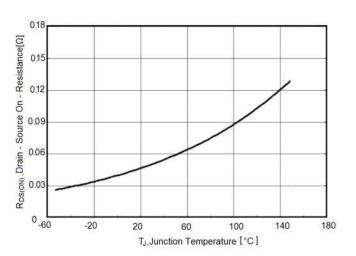
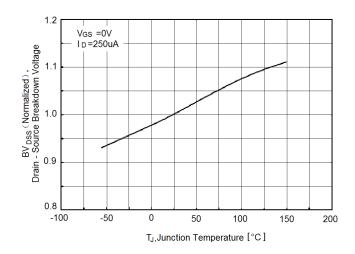
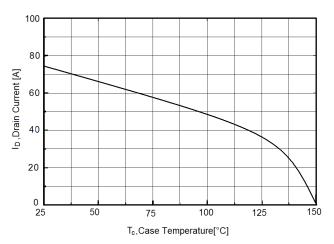




Figure8. BV_{DSS} vs Junction Temperature

Figure9. Maximum I_D vs Junction Temperature

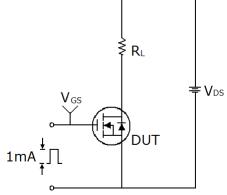


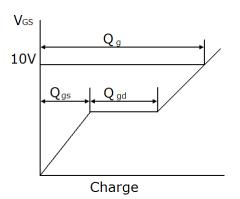




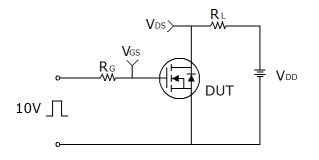
Test circuit

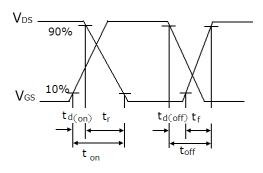
1) Gate charge test circuit & Waveform



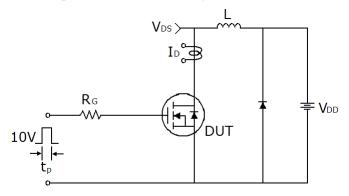


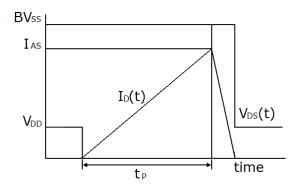
2) Switch Time Test Circuit:





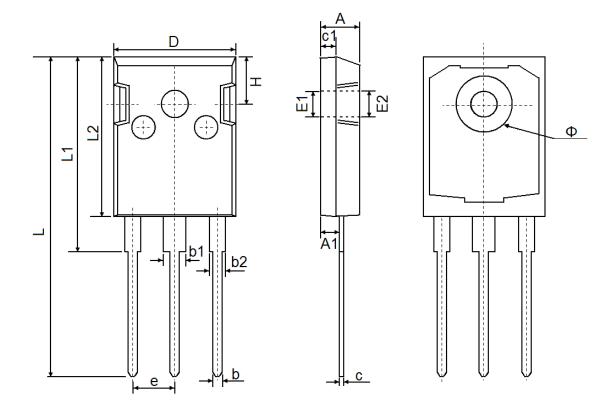
3) Unclamped Inductive Switching Test Circuit & Waveforms







TO-247 Package Information



Symbol -	Dimensions	In Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
A	4.850	5.150	0.191	0.200		
A1	2.200	2.600	0.087	0.102		
b	1.000	1.400	0.039	0.055		
b1	2.800	3.200	0.110	0.126		
b2	1.800	2.200	0.071	0.087		
С	0.500	0.700	0.020	0.028		
c1	1.900	2.100	0.075	0.083		
D	15.450	15.750	0.608	0.620		
E1	3.50	3.500 REF		0.138 REF		
E2	3.60	3.600 REF		0.142 REF		
L	40.900	41.300	1.610	1.626		
L1	24.800	25.100	0.976	0.988		
L2	20.300	20.600	0.799	0.811		
Φ	7.100	7.300	0.280	0.287		
e	5.45	5.450 TYP		5 TYP		
Н	5.980 REF 0.235 REF		5 REF			



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